

BFX38,39,40,41

CASE 79, STYLE 1
TO-39 (TO-205AD)

HIGH CURRENT TRANSISTOR

PNP SILICON

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Refer to 2N4405 for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage ($I_C = 10 \text{ mA}$)(1)	BFX38-39 BFX40-41	$V_{(\text{BR})\text{CEO}}$	55 75		V
Collector-Base Breakdown Voltage ($I_C = 10 \mu\text{A}$)	BFX38-39 BFX40-41	$V_{(\text{BR})\text{CBO}}$	55 75		V
Emitter-Base Breakdown Voltage ($I_E = 10 \mu\text{A}$)		$V_{(\text{BR})\text{EBO}}$	5		V
Collector Cutoff Current ($V_{CB} = 40 \text{ V}$) ($V_{CB} = 50 \text{ V}$) ($V_{CB} = 40 \text{ V}, T_A = 125^\circ\text{C}$) ($V_{CB} = 50 \text{ V}, T_A = 125^\circ\text{C}$)	BFX38-39 BFX40-41 BFX38-39 BFX40-41	I_{CBO}	50 50 50 50		nA μA
ON CHARACTERISTICS					
Collector-Emitter Saturation Voltage ($I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$)(1) ($I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$)(1)		$V_{CE(\text{sat})}$		0.15 0.5	V
DC Current Gain ($I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}$)(1) ($I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}$)(1) ($I_C = 500 \text{ mA}, V_{CE} = 5 \text{ V}$)(1) ($I_C = 1 \text{ A}, V_{CE} = 5 \text{ V}$)(1)	BFX38-40 BFX39-41 BFX38-40 BFX39-41 BFX38-40 BFX39-41 BFX38 BFX39 BFX40 BFX41	h_{FE}	60 30 85 40 60 25 30 15 25 10		
Emitter-Base Saturation Voltage ($I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$)(1) ($I_C = 500 \text{ mA}, I_B = 15 \text{ mA}$)(1)		$V_{BE(\text{sat})}$		0.9 1.1	V
DC Current Gain ($I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}, T_A = 125^\circ\text{C}$)(1)	BFX38-40 BFX39-41	h_{FE}	30 15		

(1) Pulsed: Pulse Duration = 300 μs , Duty Cycle = 1%.

MAXIMUM RATINGS

Rating	Symbol	BFX38 BFX39	BFX40 BFX41	Unit
Collector-Emitter Voltage	V_{CEO}	55	75	Vdc
Collector-Base Voltage	V_{CBO}	55	75	Vdc
Emitter-Base Voltage	V_{EBO}		5	Vdc
Collector Current - Continuous	I_C		1	Adc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D		1.25 7.15	Watt mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D		7 40	Watt mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R_{HJC}	20	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient	R_{HJA}	140	$^\circ\text{C/W}$

BFX38,39,40,41**ELECTRICAL CHARACTERISTICS** (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
SMALL SIGNAL CHARACTERISTICS				
Current Gain — Bandwidth Product ($I_C = 50 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 100 \text{ MHz}$)	f_T	100		MHz
Output Capacitance ($V_{CB} = 10 \text{ V}$)	C_{ob}		20	pF
Input Capacitance ($V_{EB} = 0.5 \text{ V}$)	C_{ib}		120	pF
Turn On Time ($I_C = 500 \text{ mA}$, $I_{B1} = 50 \text{ mA}$)	t_{on}		100	ns
Turn Off Time ($I_C = 500 \text{ mA}$, $I_{B1} = I_{B2} = 50 \text{ mA}$)	t_{off}		350	ns
Fall Time ($I_C = 500 \text{ mA}$, $I_{B1} = I_{B2} = 50 \text{ mA}$)	t_f		50	ns